

# MC100LVEP05

## 2.5V / 3.3V ECL 2-Input Differential AND/NAND

### Description

The MC100LVEP05 is a 2-input differential AND/NAND gate. The MC100LVEP05 is the low voltage version of the MC100EP05 and is functionally equivalent to the EL05 and LVEL05 devices. With AC performance much faster than the LVEL05 device, the MC100LVEP05 is ideal for low voltage applications requiring the fastest AC performance available.

The 100 Series contains temperature compensation.

### Features

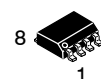
- 220 ps Typical Propagation Delay
- Input Clock Frequency > 3 GHz
- 0.2 ps Typical RMS Random Clock Period Jitter
- LVPECL Mode Operating Range:  $V_{CC} = 2.375\text{ V}$  to  $3.6\text{ V}$  with  $V_{EE} = 0\text{ V}$
- NECL Mode Operating Range:  $V_{CC} = 0\text{ V}$  with  $V_{EE} = -2.375\text{ V}$  to  $-3.6\text{ V}$
- Open Input Default State
- Q Output Will Default LOW with Inputs Open
- These are Pb-Free Devices\*



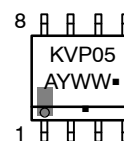
**ON Semiconductor®**

<http://onsemi.com>

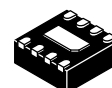
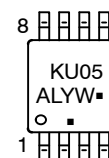
### MARKING DIAGRAMS\*



**SOIC-8**  
**D SUFFIX**  
**CASE 751**



**TSSOP-8**  
**DT SUFFIX**  
**CASE 948R**



**DFN8**  
**MN SUFFIX**  
**CASE 506AA**



|                       |                     |
|-----------------------|---------------------|
| K = MC100             | Y = Year            |
| M = Date Code         | W = Work Week       |
| A = Assembly Location | ■ = Pb-Free Package |
| L = Wafer Lot         |                     |

(Note: Microdot may be in either location)

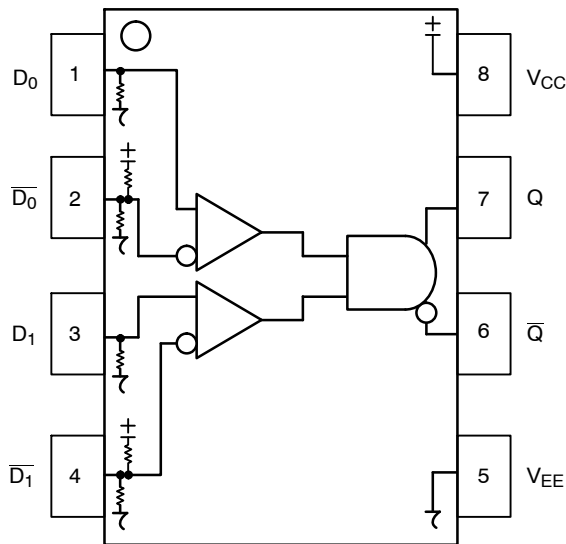
\*For additional marking information, refer to Application Note AND8002/D.

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**Figure 1. 8-Lead Pinout (Top View) and Logic Diagram**

**Table 1. PIN DESCRIPTION**

| Pin                                              | Function                                                                                                                                                                       |
|--------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D0*, D1*, $\overline{D0}$ **, $\overline{D1}$ ** | ECL Data Inputs                                                                                                                                                                |
| Q, $\overline{Q}$                                | ECL Data Outputs                                                                                                                                                               |
| V <sub>CC</sub>                                  | Positive Supply                                                                                                                                                                |
| V <sub>EE</sub>                                  | Negative Supply                                                                                                                                                                |
| EP                                               | (DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open. |

\* Pins will default LOW when left open.

\*\* Pins will default to  $V_{CC}/2$  when left open.

**Table 2. TRUTH TABLE**

| D0 | D1 | $\overline{D0}$ | $\overline{D1}$ | Q | $\overline{Q}$ |
|----|----|-----------------|-----------------|---|----------------|
| L  | L  | H               | H               | L | H              |
| L  | H  | H               | L               | L | H              |
| H  | L  | L               | H               | L | H              |
| H  | H  | L               | L               | H | L              |

**Table 3. ATTRIBUTES**

| Characteristics                                                                  | Value                                                                           |                                   |
|----------------------------------------------------------------------------------|---------------------------------------------------------------------------------|-----------------------------------|
| Internal Input Pulldown Resistor                                                 | 75 kΩ                                                                           |                                   |
| Internal Input Pullup Resistor                                                   | 37.5 kΩ                                                                         |                                   |
| ESD Protection                                                                   | Human Body Model > 4 kV<br>Machine Model > 200 V<br>Charged Device Model > 2 kV |                                   |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)<br>TSSOP-8<br>DFN8 | Pb Pkg<br>Level 1<br>Level 1                                                    | Pb-Free Pkg<br>Level 3<br>Level 1 |
| Flammability Rating                                                              | Oxygen Index: 28 to 34                                                          | UL 94 V-0 @ 0.125 in              |
| Transistor Count                                                                 | 167 Devices                                                                     |                                   |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test                           |                                                                                 |                                   |

1. For additional information, see Application Note AND8003/D.

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**Table 4. MAXIMUM RATINGS**

| Symbol           | Parameter                                | Condition 1           | Condition 2                      | Rating      | Unit |
|------------------|------------------------------------------|-----------------------|----------------------------------|-------------|------|
| V <sub>CC</sub>  | PECL Mode Power Supply                   | V <sub>EE</sub> = 0 V |                                  | 6           | V    |
| V <sub>EE</sub>  | NECL Mode Power Supply                   | V <sub>CC</sub> = 0 V |                                  | –6          | V    |
| V <sub>I</sub>   | PECL Mode Input Voltage                  | V <sub>EE</sub> = 0 V | V <sub>I</sub> ≤ V <sub>CC</sub> | 6           | V    |
|                  | NECL Mode Input Voltage                  | V <sub>CC</sub> = 0 V | V <sub>I</sub> ≥ V <sub>EE</sub> | –6          | V    |
| I <sub>out</sub> | Output Current                           | Continuous            |                                  | 50          | mA   |
|                  |                                          | Surge                 |                                  | 100         | mA   |
| T <sub>A</sub>   | Operating Temperature Range              |                       |                                  | –40 to +85  | °C   |
| T <sub>stg</sub> | Storage Temperature Range                |                       |                                  | –65 to +150 | °C   |
| θ <sub>JA</sub>  | Thermal Resistance (Junction–to–Ambient) | 0 lfpm                | TSSOP–8                          | 185         | °C/W |
|                  |                                          | 500 lfpm              | TSSOP–8                          | 140         | °C/W |
| θ <sub>JC</sub>  | Thermal Resistance (Junction–to–Case)    | Standard Board        | TSSOP–8                          | 41 to 44    | °C/W |
| θ <sub>JA</sub>  | Thermal Resistance (Junction–to–Ambient) | 0 lfpm                | DFN8                             | 129         | °C/W |
|                  |                                          | 500 lfpm              | DFN8                             | 84          | °C/W |
| T <sub>sol</sub> | Wave Solder                              | 3 sec @ 260°C         |                                  | 265         | °C   |
| θ <sub>JC</sub>  | Thermal Resistance (Junction–to–Case)    | (Note 2)              | DFN8                             | 35 to 40    | °C/W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

2. JEDEC standard multilayer board – 2S2P (2 signal, 2 power)

**Table 5. 100EP DC CHARACTERISTICS, PECL V<sub>CC</sub> = 2.5 V, V<sub>EE</sub> = 0 V (Note 3)**

| Symbol             | Characteristic                                                                 | –40°C  |             |      | 25°C        |      |      | 85°C        |      |      | Unit |
|--------------------|--------------------------------------------------------------------------------|--------|-------------|------|-------------|------|------|-------------|------|------|------|
|                    |                                                                                | Min    | Typ         | Max  | Min         | Typ  | Max  | Min         | Typ  | Max  |      |
| I <sub>EE</sub>    | Power Supply Current                                                           | 15     | 25          | 32   | 17          | 27   | 36   | 19          | 28   | 38   | mA   |
| V <sub>OH</sub>    | Output HIGH Voltage (Note 4)                                                   | 1355   | 1480        | 1605 | 1355        | 1480 | 1605 | 1355        | 1480 | 1605 | mV   |
| V <sub>OL</sub>    | Output LOW Voltage (Note 4)                                                    | 555    | 730         | 900  | 555         | 730  | 900  | 555         | 730  | 900  | mV   |
| V <sub>IH</sub>    | Input HIGH Voltage (Single–Ended)                                              | 1355   |             | 1620 | 1355        |      | 1620 | 1355        |      | 1620 | mV   |
| V <sub>IL</sub>    | Input LOW Voltage (Single–Ended)                                               | 555    |             | 900  | 555         |      | 900  | 555         |      | 900  | mV   |
| V <sub>IHCMR</sub> | Input HIGH Voltage Common Mode Range (Differential Configuration) (Notes 5, 6) | 1.2    |             | 2.5  | 1.2         |      | 2.5  | 1.2         |      | 2.5  | V    |
| I <sub>IH</sub>    | Input HIGH Current                                                             |        |             | 150  |             |      | 150  |             |      | 150  | μA   |
| I <sub>IL</sub>    | Input LOW Current                                                              | D<br>D | 0.5<br>–150 |      | 0.5<br>–150 |      |      | 0.5<br>–150 |      |      | μA   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.125 V to –1.3 V.

4. All loading with 50 Ω to V<sub>CC</sub> – 2.0 V.

5. Single–ended input CLK pin operation is limited to V<sub>CC</sub> ≥ 3.0 V in PECL mode.

6. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>. V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

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**Table 6. 100EP DC CHARACTERISTICS, PECL**  $V_{CC} = 3.3\text{ V}$ ,  $V_{EE} = 0\text{ V}$  (Note 7)

| Symbol      | Characteristic                                                             | -40°C  |             |      | 25°C        |      |      | 85°C        |      |      | Unit          |
|-------------|----------------------------------------------------------------------------|--------|-------------|------|-------------|------|------|-------------|------|------|---------------|
|             |                                                                            | Min    | Typ         | Max  | Min         | Typ  | Max  | Min         | Typ  | Max  |               |
| $I_{EE}$    | Power Supply Current                                                       | 15     | 25          | 32   | 17          | 27   | 36   | 19          | 28   | 38   | mA            |
| $V_{OH}$    | Output HIGH Voltage (Note 8)                                               | 2155   | 2280        | 2405 | 2155        | 2280 | 2405 | 2155        | 2280 | 2405 | mV            |
| $V_{OL}$    | Output LOW Voltage (Note 8)                                                | 1355   | 1530        | 1700 | 1355        | 1530 | 1700 | 1355        | 1530 | 1700 | mV            |
| $V_{IH}$    | Input HIGH Voltage (Single-Ended)                                          | 2075   |             | 2420 | 2075        |      | 2420 | 2075        |      | 2420 | mV            |
| $V_{IL}$    | Input LOW Voltage (Single-Ended)                                           | 1355   |             | 1675 | 1355        |      | 1675 | 1355        |      | 1675 | mV            |
| $V_{IHCMR}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 9) | 1.2    |             | 3.3  | 1.2         |      | 3.3  | 1.2         |      | 3.3  | V             |
| $I_{IH}$    | Input HIGH Current                                                         |        |             | 150  |             |      | 150  |             |      | 150  | $\mu\text{A}$ |
| $I_{IL}$    | Input LOW Current                                                          | D<br>D | 0.5<br>-150 |      | 0.5<br>-150 |      |      | 0.5<br>-150 |      |      | $\mu\text{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

7. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.3 V to -2.2 V.

8. All loading with  $50\ \Omega$  to  $V_{CC} - 2.0\text{ V}$ .

9.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ .  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal.

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**Table 7. 100EP DC CHARACTERISTICS, NECL**  $V_{CC} = 0\text{ V}$ ,  $V_{EE} = -2.375\text{ V}$  to  $-3.6\text{ V}$  (Note 10)

| Symbol      | Characteristic                                                              | -40°C        |       |       | 25°C         |       |       | 85°C         |       |       | Unit          |
|-------------|-----------------------------------------------------------------------------|--------------|-------|-------|--------------|-------|-------|--------------|-------|-------|---------------|
|             |                                                                             | Min          | Typ   | Max   | Min          | Typ   | Max   | Min          | Typ   | Max   |               |
| $I_{EE}$    | Power Supply Current                                                        | 15           | 25    | 32    | 17           | 27    | 36    | 19           | 28    | 38    | mA            |
| $V_{OH}$    | Output HIGH Voltage (Note 11)                                               | -1145        | -1020 | -895  | -1145        | -1020 | -895  | -1145        | -1020 | -895  | mV            |
| $V_{OL}$    | Output LOW Voltage (Note 11)                                                | -1945        | -1770 | -1600 | -1945        | -1770 | -1600 | -1945        | -1770 | -1600 | mV            |
| $V_{IH}$    | Input HIGH Voltage (Single-Ended)                                           | -1165        |       | -880  | -1165        |       | -880  | -1165        |       | -880  | mV            |
| $V_{IL}$    | Input LOW Voltage (Single-Ended)                                            | -1945        |       | -1600 | -1945        |       | -1600 | -1945        |       | -1600 | mV            |
| $V_{IHCMR}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 12) | $V_{EE}+1.2$ |       | 0.0   | $V_{EE}+1.2$ |       | 0.0   | $V_{EE}+1.2$ |       | 0.0   | V             |
| $I_{IH}$    | Input HIGH Current                                                          |              |       | 150   |              |       | 150   |              |       | 150   | $\mu\text{A}$ |
| $I_{IL}$    | Input LOW Current                                                           | D            | 0.5   |       | 0.5          |       |       | 0.5          |       |       | $\mu\text{A}$ |
|             |                                                                             | $\bar{D}$    | -150  |       | -150         |       |       | -150         |       |       |               |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

10. Input and output parameters vary 1:1 with  $V_{CC}$ .

11. All loading with  $50\ \Omega$  to  $V_{CC} - 2.0\text{ V}$ .

12.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ ;  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal.

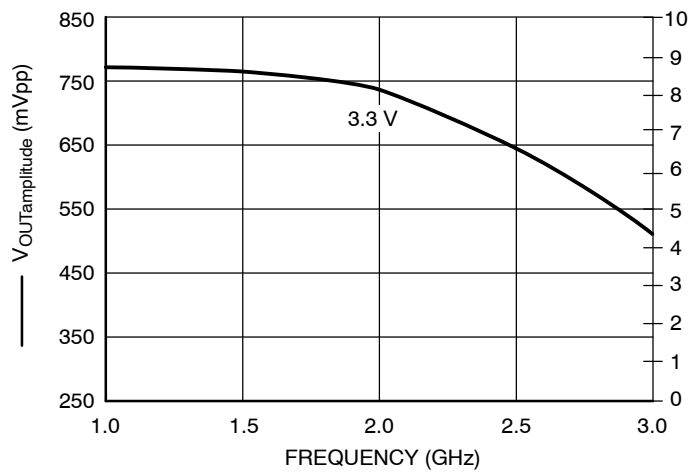
**Table 8. AC CHARACTERISTICS**  $V_{CC} = 0\text{ V}$ ;  $V_{EE} = -2.375\text{ V}$  to  $-3.6\text{ V}$  or  $V_{CC} = 2.375\text{ V}$  to  $3.6\text{ V}$ ;  $V_{EE} = 0\text{ V}$  (Note 13)

| Symbol                   | Characteristic                                                  | -40°C |     |      | 25°C |     |      | 85°C |     |      | Unit |
|--------------------------|-----------------------------------------------------------------|-------|-----|------|------|-----|------|------|-----|------|------|
|                          |                                                                 | Min   | Typ | Max  | Min  | Typ | Max  | Min  | Typ | Max  |      |
| $f_{\max}$               | Maximum Frequency (Figure 2)                                    | 3.0   |     |      | 3.0  |     |      | 3.0  |     |      | GHz  |
| $t_{PLH}$ ,<br>$t_{PHL}$ | Propagation Delay to Output Differential                        | 160   | 210 | 260  | 170  | 220 | 270  | 210  | 260 | 320  | ps   |
| $t_{JITTER}$             | RMS Random Clock Jitter $f_{in} \leq 3.0\text{ GHz}$ (Figure 2) |       | 0.2 | 1    |      | 0.2 | 1    |      | 0.2 | 1.5  | ps   |
| $V_{PP}$                 | Input Voltage Swing (Differential Configuration)                | 150   | 800 | 1200 | 150  | 800 | 1200 | 150  | 800 | 1200 | mV   |
| $t_r$ ,<br>$t_f$         | Output Rise/Fall Times (20% – 80%)                              | 70    | 120 | 170  | 80   | 130 | 180  | 100  | 150 | 200  | ps   |

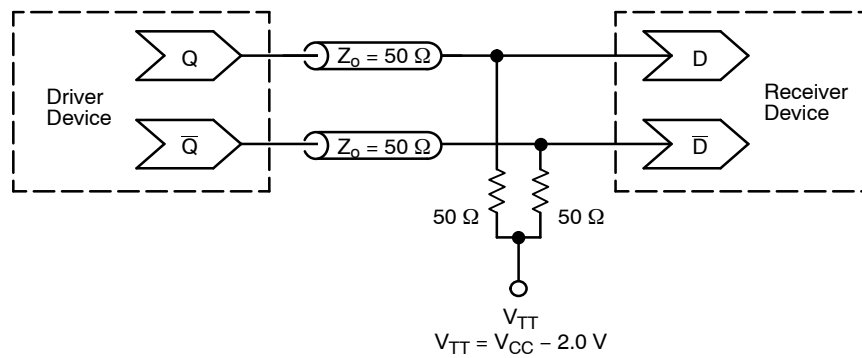
NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

13. Measured using a 750 mV source, 50% duty cycle clock source. All loading with  $50\ \Omega$  to  $V_{CC} - 2.0\text{ V}$ .

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**Figure 2.  $F_{max}$  @ 25°C**



**Figure 3. Typical Termination for Output Driver and Device Evaluation**  
(See Application Note AND8020/D – Termination of ECL Logic Devices.)

## MC100LVEP05

### ORDERING INFORMATION

| Device           | Package              | Shipping <sup>†</sup> |
|------------------|----------------------|-----------------------|
| MC100LVEP05DG    | SOIC-8<br>(Pb-Free)  | 98 Units / Rail       |
| MC100LVEP05DR2G  | SOIC-8<br>(Pb-Free)  | 2500 / Tape & Reel    |
| MC100LVEP05DTG   | TSSOP-8<br>(Pb-Free) | 100 Units / Rail      |
| MC100LVEP05DTR2G | TSSOP-8<br>(Pb-Free) | 2500 / Tape & Reel    |
| MC100LVEP05MNTXG | DFN8<br>(Pb-Free)    | 1000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

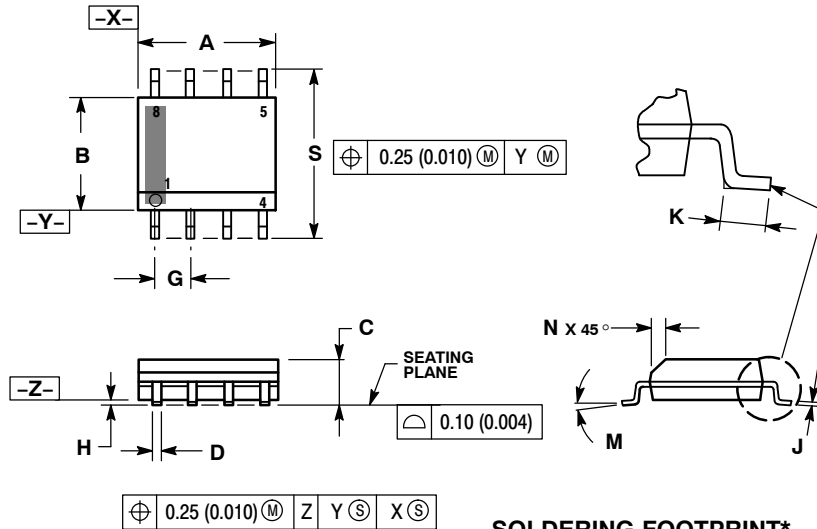
### Resource Reference of Application Notes

- AN1405/D** – ECL Clock Distribution Techniques
- AN1406/D** – Designing with PECL (ECL at +5.0 V)
- AN1503/D** – ECLinPS™ I/O SPICE Modeling Kit
- AN1504/D** – Metastability and the ECLinPS Family
- AN1568/D** – Interfacing Between LVDS and ECL
- AN1672/D** – The ECL Translator Guide
- AND8001/D** – Odd Number Counters Design
- AND8002/D** – Marking and Date Codes
- AND8020/D** – Termination of ECL Logic Devices
- AND8066/D** – Interfacing with ECLinPS
- AND8090/D** – AC Characteristics of ECL Devices

# MC100LVEP05

## PACKAGE DIMENSIONS

SOIC-8 NB  
CASE 751-07  
ISSUE AJ

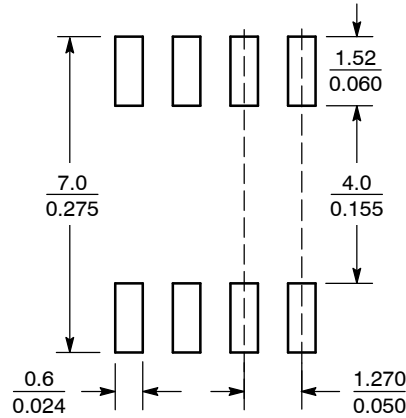


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.80        | 5.00 | 0.189     | 0.197 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.053     | 0.069 |
| D   | 0.33        | 0.51 | 0.013     | 0.020 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| H   | 0.10        | 0.25 | 0.004     | 0.010 |
| J   | 0.19        | 0.25 | 0.007     | 0.010 |
| K   | 0.40        | 1.27 | 0.016     | 0.050 |
| M   | 0°          | 8°   | 0°        | 8°    |
| N   | 0.25        | 0.50 | 0.010     | 0.020 |
| S   | 5.80        | 6.20 | 0.228     | 0.244 |

### SOLDERING FOOTPRINT\*



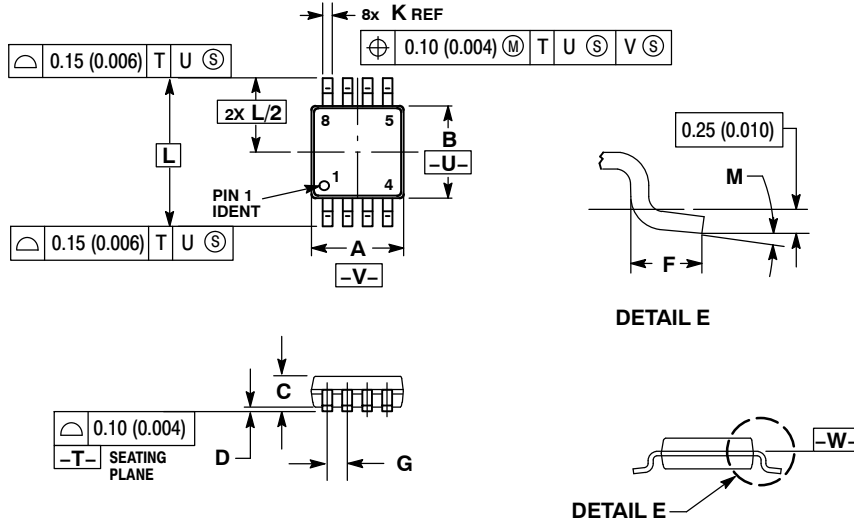
SCALE 6:1  $\left( \frac{\text{mm}}{\text{inches}} \right)$

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MC100LVEP05

## PACKAGE DIMENSIONS

**TSSOP-8**  
**DT SUFFIX**  
 PLASTIC TSSOP PACKAGE  
 CASE 948R-02  
 ISSUE A



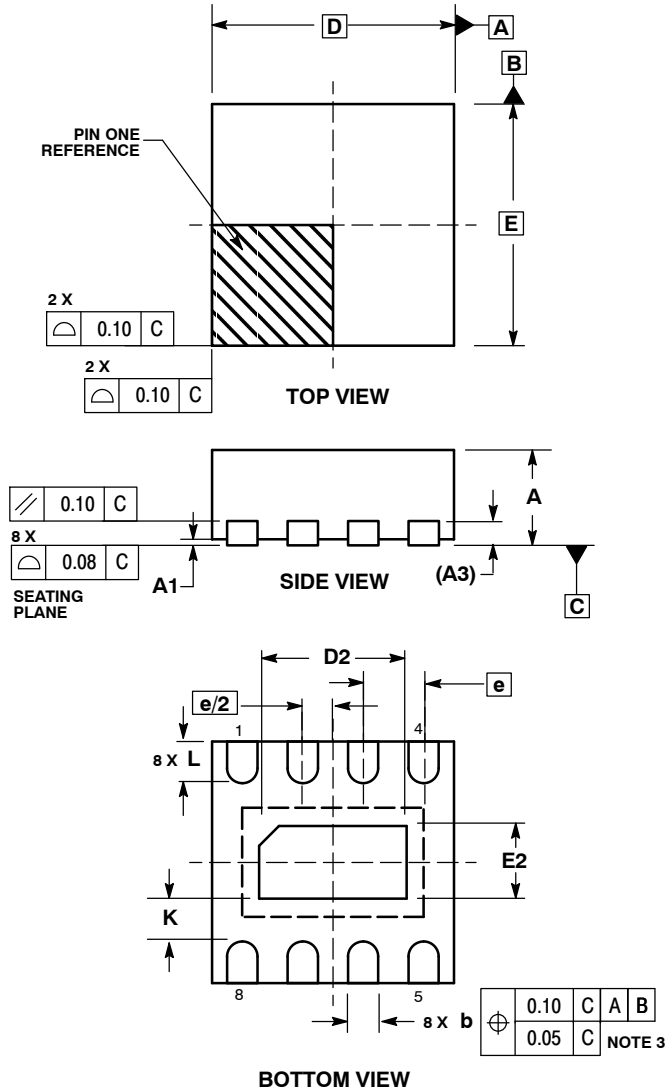
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 2.90        | 3.10 | 0.114     | 0.122 |
| B   | 2.90        | 3.10 | 0.114     | 0.122 |
| C   | 0.80        | 1.10 | 0.031     | 0.043 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.40        | 0.70 | 0.016     | 0.028 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| K   | 0.25        | 0.40 | 0.010     | 0.016 |
| L   | 4.90 BSC    |      | 0.193 BSC |       |
| M   | 0°          | 6°   | 0°        | 6°    |

# MC100LVEP05

## PACKAGE DIMENSIONS

DFN8  
CASE 506AA-01  
ISSUE D



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994 .
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS |      |
|-----|-------------|------|
|     | MIN         | MAX  |
| A   | 0.80        | 1.00 |
| A1  | 0.00        | 0.05 |
| A3  | 0.20 REF    |      |
| b   | 0.20        | 0.30 |
| D   | 2.00 BSC    |      |
| D2  | 1.10        | 1.30 |
| E   | 2.00 BSC    |      |
| E2  | 0.70        | 0.90 |
| e   | 0.50 BSC    |      |
| K   | 0.20        | ---  |
| L   | 0.25        | 0.35 |

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